

SPM PROBES & TEST STRUCTURES

MikroMasch® product catalogue

2015

High Quality and Consistency

- Tip sharpness better than 10 nm
- High Q-factor and smooth resonance curves
- Ideal reflectivity from the backside of the cantilever
- For the old non-HQ price



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MikroMasch® SPM Probes & Test Structures

www.spmtips.com

ALL SPM TIPS IMPROVED TO HQ

Improved HQ Probes

All MikroMasch probes have been upgraded to an improved design, called the HQ Line (High Quality Line).

Since November 2012 all MikroMasch SPM probes are being manufactured with the new HQ (High Quality) AFM probe technology. The pricing is kept at the same inexpensive level as before.

HQ is the next generation of MikroMasch probes distinguished by its high quality and high repeatability of characteristics. In particular, the probes have much more consistent reflectivity of uncoated cantilevers, tip radius and quality factor compared to our former standard probes. The HQ probe chips have cut corners that allow them to be used at an angle from the vertical. Described below are some of the main advantages of the improved HQ Probes.

RADIUS OF CURVATURE

The radius of curvature measures the sharpness of a particular probe. Typically, the sharper the curvature radius the more fragile a silicon tip is. Conversely, a larger curvature radius provides greater durability, but reduces the benefits of a sharper tip.

Achieving a consistent balance delivers reliable and accurate results. 94% of HQ probes have a radius of curvature between 7 and 10 nm.







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MikroMasch[®] Distributor



TIP SHAPE FACTOR

A higher value indicates a higher aspect ratio probe. A tighter range of values indicates a more consistent tip shape.

Results of the tip shape factor tests show consistent and close grouping of data. Known tip shape insures accuracy of results. 92% of HQ probes have an aspect ratio between 1.4 and 1.8.

RESONANCE FREOUENCY

Probes are designed to maintain a tight range of resonance frequencies. Reliability in cantilever specifications ensures dependable measurement results.

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HQ: 4-lever

The New HQ Line & Test Structures

Probe chip specifications .																						
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16

HARD LONG SCANNING / LIFETIME

CONDUCTIVE

DPER: High Resolution Conductive silicon probes	10
DPE: Low Noise Conductive silicon probes	11
Conductive Noncontact and Contact silicon probes	12

MAGNETIC

Magnetic Noncontact silicon probes																		14
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HIGH RESOLUTION

MIX & MATCH

Mix&Match																																
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TEST STRUCTURES

TGXYZ Series Calibration standards 17	
TGX Series Calibration standards	
TGF11 Series Calibration standards	
PA Series Calibration standards	
HOPG	

RECOMENDATIONS

HQ:NSC/CSC 1-lever

Cantilever material	
Tip shape	
Tip height	





🛄 HQ:NSC 3-lever

Cantilever materia	Ι.										n-type silicon
Tip shape											pyramidal
Tip height		•		•	•	•	•		•	•	12 - 18 µm



HQ: NSC Tipless 3-lever

16mn

Series: 35, 36



HQ:CSC 3-lever

Cantilever material	 	n-type silicon
Tip shape	 	pyramidal
Tip height	 	. 12 - 18 µm

Series: 37, 38





HQ: CSC Tipless 3-lever



Series: 37, 38 Tipless

Series: 35,36 Tipless



HQ: NSC, CSC & XSC In the second seco



Pyramidal silicon etched probes* are characterized by high tip sharpness and narrow resonance peaks, making them very suitable for topography imaging in dynamic AFM modes and compositional mapping. These probes are available in a wide range of resonance frequencies and spring constants.

Tip properties:	Backside coating:
Tip radius	AI BS
Tip material silicon	no Al
	Cr-Au BS Au 30 nm on Cr 20 nm sublayer

SEM image of the regular

Cantilever	Available	Length	Width	Thickness	Resonanc	e Frequency	Force Constant				
Series	Coatings	l, ±5 μm	w, ±3 μm	±0.5 μm	ł	Ήz		N/m			
					(typical)	(range)	(typical)	(range)			
∎ ▼	•	▼	▼	▼	▼	▼	•	▼			
HQ:NSC14	/No Al, /Al BS	125	25	2.1	160	110 - 220	5.0	1.8 - 13			
HQ:NSC15	/No Al, /Al BS, /Cr-Au BS	125	30	4.0	325	265 - 410	40	20 - 80			
HQ:NSC16	/No Al, /Al BS	225	37.5	7.0	190	170 - 210	45	30 - 70			
HQ:CSC17	/No AI, /AI BS	450	50	2.0	13	10 - 17	0.18	0.06 - 0.40			
HQ:NSC18	/No Al, /Al BS, /Cr-Au BS	225	27.5	3.0	75	60 - 90	2.8	1.2 - 5.5			
HQ:NSC19	/No Al, /Al BS	125	22.5	1.0	65	25 - 120	0.5	0.05 - 2.3			
[]]											
HQ:NSC35											
lever A		110	35	2.0	205	130 - 290	8.9	2.7 - 24			
lever B	/No Al, /Al BS, /Cr-Au BS	90	35	2.0	300	185 - 430	16	4.8 - 44			
lever C		130	35	2.0	150	95 - 205	5.4	1.7 - 14			
HQ:NSC36											
lever A		110	32.5	1.0	90	30 - 160	1.0	0.1 - 4.6			
lever B	/No Al, /Al BS, /Cr-Au BS	90	32.5	1.0	130	45 - 240	2	0.2 - 9			
lever C		130	32.5	1.0	65	25 - 115	0.6	0.06 - 2.7			
											
HQ:CSC37											
lever A		250	35	2.0	40	30 - 55	0.8	0.3 - 2			
lever B	/No AI, /AI BS	350	35	2.0	20	15 - 30	0.3	0.1 - 0.6			
lever C		300	35	2.0	30	20 - 40	0.4	0.1 - 1			
HQ:CSC38											
lever A		250	32.5	1.0	20	8 - 32	0.09	0.01 - 0.36			
lever B	/No AI, /AI BS	350	32.5	1.0	10	5 - 17	0.03	0.003 - 0.13			
lever C		300	32.5	1.0	14	6 - 23	0.05	0.005 - 0.21			
4×											
HQ:XSC11											
lever A		500	30	2.7	15	12 - 18	0.2	0.1 - 0.4			
lever B	/No AL /ALBS	210	30	2.7	80	60 - 100	2.7	1.1 - 5.6			
lever C	///////////////////////////////////	150	30	2.7	155	115 - 200	7	3 - 16			
lever D		100	50	2.7	350	250 - 465	42	17 - 90			

APPLICATION

Phase imaging is among the AFM techniques that can be used to determine nanoscale differences in the properties of a heterogeneous system or of samples with inherent heterogeneity. Phase contrast is dependent on interactions between the tip and the sample, but those interactions are in turn partially dependent on the scan parameters and whether the image is being taken in an attractive or repulsive mode. O'Dea and Burrato used phase imaging to map the proton-conducting domains of a Nafion membrane. They found that the specific interaction forces between the tip and the sample significantly affected the resolution of the proton conducting domains. Imaging in a repulsive regime resulted in an overestimation of the area of the domains and an underestimation in the number of domains. Imaging in an attractive regime resulted in the most accurate phase imaging of the aqueous and fluorocarbon domains of the membrane. When the feedback loop was not optimized or the cantilever was driven above resonance, the phase corresponded with changes in topography rather than changes in the composition of the sample.

In figures (a) and (b) the phase data from repulsive and attractive regimes, respectively, have been overlaid on the corresponding topography image. Features of the phase contrast in the repulsive regime correspond to some features in the topography, while the phase contrast in the attractive regime is independent of the topography. Images were taken with the NSC15/AIBS (now upgraded to HQ:NSC15/AIBS). (O'Dea, J.R. and Burrato, S.K.; J. Phys. Chem. B 2011, 115, 1014-1020.)





^{*} Please refer to our pricelist for available package sizes.

HARD 4×

Tipless Cantilevers

Tipless Noncontact (NSC) and Contact (CSC) three-lever silicon probes



Probes of the Tipless Series feature 3 tipless cantilevers* with different spring constants and resonance frequencies on one side of the chip. This series replaces the former 12 Series.

Backside coating:	Cr-Au coated
AI BS	Au overall coating
no Al	Cr overall sublayer

SEM image of a tipless silicon cantilever

Series Coatings I, ± 5 µm w, ± 3 µm ± 0.5 µm kHZ N/m Itelever A Itelever A </th <th>Cantilever</th> <th>Available</th> <th>Length</th> <th>Width</th> <th>Thickness</th> <th colspan="2">Resonance Frequency</th> <th>Force</th> <th>Constant</th>	Cantilever	Available	Length	Width	Thickness	Resonance Frequency		Force	Constant
Index Index <th< th=""><th>Series</th><th>Coatings</th><th>I, \pm 5 μm</th><th>w, ± 3 μm</th><th>±0.5 µm</th><th colspan="2">kHz</th><th></th><th>N/m</th></th<>	Series	Coatings	I, \pm 5 μ m	w, ± 3 μm	±0.5 µm	kHz			N/m
HQ:NSC35/Tiples I10 35 2.0 205 130-290 8.9 2.7-24 lever A 90 35 2.0 300 185-430 16 4.8-44 lever C 130 35 2.0 150 95-205 5.4 1.7-14 HQ:NSC36/Tiples 110 32.5 1.0 90 30-160 1.0 0.1-4.6 lever A 100 32.5 1.0 90 30-160 1.0 0.1-4.6 lever B /No Al, /AI BS, /Cr-Au 90 32.5 1.0 90 30-160 1.0 0.1-4.6 lever C 130 32.5 1.0 130 45-240 2 0.2-9 lever C 130 32.5 1.0 130 45-240 2 0.2-9 lever C 130 32.5 1.0 130 45-240 2 0.2-9 lever A 30 35 2.0 40 30-55 0.8 0.3-2 lever A </th <th></th> <th></th> <th></th> <th></th> <th></th> <th>(typical)</th> <th>(range)</th> <th>(typical)</th> <th>(range)</th>						(typical)	(range)	(typical)	(range)
HQ:NSC35/Tipless lever A 110 35 2.0 205 130 - 290 8.9 2.7 - 24 lever B /No Al, /AI BS, /Cr-Au 90 35 2.0 300 185 - 430 16 4.8 - 44 lever C 130 35 2.0 150 95 - 205 5.4 1.7 - 14 HQ:NSC36/Tipless 110 32.5 1.0 90 30 - 160 1.0 0.1 - 4.6 lever A 00 32.5 1.0 90 30 - 160 1.0 0.1 - 4.6 lever B /No Al, /AI BS, /Cr-Au 90 32.5 1.0 130 45 - 240 2 0.2 - 9 lever A 100 32.5 1.0 130 45 - 240 2 0.2 - 9 lever A 130 32.5 1.0 130 45 - 240 2 0.2 - 9 lever A 30 32.5 1.0 65 25 - 115 0.6 0.6 - 2.7 lever A 300 350 35		•	•	•	•	•	•	•	•
Iever A 110 35 2.0 205 130-290 8.9 2.7-24 Iever B /No AI, /AI BS, /Cr-Au 90 35 2.0 300 185-430 16 4.8-44 Iever C 130 35 2.0 150 95-205 5.4 1.7-14 HQ:NSC36/Tipless 110 32.5 1.0 90 30-160 1.0 0.1-4.6 Iever A 00 32.5 1.0 90 30-160 1.0 0.1-4.6 Iever B /No AI, /AI BS, /Cr-Au 90 32.5 1.0 130 45-240 2 0.2-9 Iever C 130 32.5 1.0 130 45-240 2 0.2-9 Iever A 90 32.5 1.0 165 25-115 0.6 0.06-2.7 Iever A 250 35 2.0 40 30-55 0.8 0.3-2 Iever A /No AI, /AI BS, /Cr-Au 350 35 2.0 20 15-30	HQ:NSC35/Tiples	SS							
Iever B /No AI, /AI BS, /Cr-Au 90 35 2.0 300 185 - 430 16 4.8 - 44 Iever C 130 35 2.0 150 95 - 205 5.4 1.7 - 14 HQ:NSC36/Tipless 110 32.5 1.0 90 30 - 160 1.0 0.1 - 4.6 Iever A 100 32.5 1.0 90 30 - 160 2 0.2 - 9 Iever C 130 32.5 1.0 130 45 - 240 2 0.2 - 9 Iever C 130 32.5 1.0 65 25 - 115 0.6 0.06 - 2.7 Iever A 130 32.5 1.0 65 25 - 115 0.6 0.06 - 2.7 Iever A 250 35 2.0 40 30 - 55 0.8 0.3 - 2 Iever A 70.0 Al, /AI BS, /Cr-Au 350 35 2.0 15 - 30 0.3 0.1 - 0.6 Iever C 70.0 Al, /AI BS, /Cr-Au 300 35 2.0 20 - 40	lever A		110	35	2.0	205	130 - 290	8.9	2.7 - 24
lever C 130 35 2.0 150 95-205 5,4 1.7-14 HQ:NSC36/Tipless lever A No Al, /AI BS, /Cr-Au 110 32.5 1.0 90 30-160 1.0 0.1-4.6 lever B /No Al, /AI BS, /Cr-Au 90 32.5 1.0 130 45-240 2 0.2-9 lever C 130 32.5 1.0 65 25-115 0.6 0.06-2.7 HQ:CSC37/Tipless	lever B	/No AI, /AI BS, /Cr-Au	90	35	2.0	300	185 - 430	16	4.8 - 44
HQ:NSC36/Tipless lever A No Al, /Al BS, /Cr-Au 110 32.5 1.0 90 30 - 160 1.0 0.1 - 4.6 lever B /No Al, /Al BS, /Cr-Au 90 32.5 1.0 130 45 - 240 2 0.2 - 9 lever C 130 32.5 1.0 65 25 - 115 0.6 0.06 - 2.7 HQ:CSC37/Tipless	lever C		130	35	2.0	150	95 - 205	5.4	1.7 - 14
lever A 110 32.5 1.0 90 30-160 1.0 0.1-4.6 lever B /No Al, /AI BS, /Cr-Au 90 32.5 1.0 130 45-240 2 0.2-9 lever C 130 32.5 1.0 65 25-115 0.6 0.06-2.7 HQ:CSC37/Tiples lever A 250 35 2.0 40 30-55 0.8 0.3-2 lever A 250 35 2.0 40 30-55 0.8 0.3-2 lever B /No Al, /AI BS, /Cr-Au 350 35 2.0 20 15-30 0.3 0.1-0.6 lever C 300 35 2.0 30 20-40 0.4 0.1-1	HQ:NSC36/Tipless	3							
Iever B /No AI, /AI BS, /Cr-Au 90 32.5 1.0 130 45 - 240 2 0.2 - 9 Iever C 130 32.5 1.0 65 25 - 115 0.6 0.06 - 2.7 Image: A control of the control of th	lever A		110	32.5	1.0	90	30 - 160	1.0	0.1 - 4.6
lever C 130 32.5 1.0 65 25 - 115 0.6 0.06 - 2.7 HQ:CSC37/Tipless HQ:CSC37/Tipless 100 65 25 - 115 0.6 0.06 - 2.7 lever A 250 35 2.0 40 30 - 55 0.8 0.3 - 2 lever B /No Al, /AI BS, /Cr-Au 350 35 2.0 20 15 - 30 0.3 0.1 - 0.6 lever C 300 35 2.0 30 20 - 40 0.4 0.1 - 1	lever B	/No AI, /AI BS, /Cr-Au	90	32.5	1.0	130	45 - 240	2	0.2 - 9
HQ:CSC37/Tipless 250 35 2.0 40 30 - 55 0.8 0.3 - 2 lever A /No Al, /AI BS, /Cr-Au 350 35 2.0 40 30 - 55 0.8 0.3 - 2 lever B /No Al, /AI BS, /Cr-Au 350 35 2.0 20 15 - 30 0.3 0.1 - 0.6 lever C 300 35 2.0 30 20 - 40 0.4 0.1 - 1	lever C		130	32.5	1.0	65	25 - 115	0.6	0.06 - 2.7
HQ:CSC37/Tipless 250 35 2.0 40 30 - 55 0.8 0.3 - 2 lever A /No Al, /Al BS, /Cr-Au 350 35 2.0 20 15 - 30 0.3 0.1 - 0.6 lever B /No Al, /Al BS, /Cr-Au 300 35 2.0 20 15 - 30 0.3 0.1 - 0.6									
lever A 250 35 2.0 40 30 - 55 0.8 0.3 - 2 lever B /No Al, /Al BS, /Cr-Au 350 35 2.0 20 15 - 30 0.3 0.1 - 0.6 lever C 300 35 2.0 30 20 - 40 0.4 0.1 - 1	HQ:CSC37/Tipless								
lever B /No Al, /Al BS, /Cr-Au 350 35 2.0 20 15 - 30 0.3 0.1 - 0.6 lever C 300 35 2.0 30 20 - 40 0.4 0.1 - 1	lever A		250	35	2.0	40	30 - 55	0.8	0.3 - 2
lever C 300 35 2.0 30 20 - 40 0.4 0.1 - 1	lever B	/No AI, /AI BS, /Cr-Au	350	35	2.0	20	15 - 30	0.3	0.1 - 0.6
	lever C		300	35	2.0	30	20 - 40	0.4	0.1 - 1
HQ:CSC38/Tipless	HQ:CSC38/Tipless								
lever A 250 32.5 1.0 20 8 - 32 0.09 0.01 - 0.36	lever A		250	32.5	1.0	20	8 - 32	0.09	0.01 - 0.36
lever B /No Al, /Al BS, /Cr-Au 350 32.5 1.0 10 5 - 17 0.03 0.003 - 0.13	lever B	/No AI, /AI BS, /Cr-Au	350	32.5	1.0	10	5 - 17	0.03	0.003 - 0.13
lever C 300 32.5 1.0 14 6-23 0.05 0.005-0.2	lever C		300	32.5	1.0	14	6 - 23	0.05	0.005 - 0.21

* See specifications on page 5

APPLICATION

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Tipless cantilevers can be used for measurements of material properties and interactions. Different objects such as glass spheres or polystyrene particles can also be mounted on tipless cantilevers to make them applicable for AFM-like experiments.



* Please refer to our pricelist for available package sizes.

Series HARD

Hardened DLC coated silicon probes



The HARD series silicon etched probe* tips have pyramidal shape. The probes are coated with a hard DLC film. The backside of the cantilevers is coated with the 30 nm aluminium reflective film.

Typical tip radius	•			•	·	<20 nm
Tipside coating						DLC 20 nm
Backside coating.						. Al 30 nm

SEM image of the HARD tip

Cantilever	Available	Length	Width	Thickness	Resonance Frequency		Force	Constant
Series	Coatings	l, ±5 μm	w, ±3 μm	±0.5 μm	kHz		1	N/m
					(typical)	(range)	(typical)	(range)
- ▼	•	•	▼	•	•	•	▼	▼
HQ:NSC14	/Hard/AI BS	125	25	2.1	160	110 - 220	5.0	1.8 - 13
HQ:NSC15	/Hard/AI BS	125	30	4.0	325	265 - 410	40	20 - 80
HQ:NSC16	/Hard/AI BS	225	37.5	7.0	190	170 - 210	45	30 - 70
HQ:CSC17	/Hard/AI BS	450	50	2.0	13	10 - 17	0.18	0.06 - 0.40
HQ:NSC18	/Hard/AI BS	225	27.5	27.5	75	60 - 90	2.8	1.2 - 5.50
[]]								
HQ:NSC35								
lever A	/Hard/AI BS	110	35	2.0	205	130 - 290	8.9	2.7 - 24
lever B		90	35	2.0	300	185 - 430	16	4.8 - 44
lever C		130	35	2.0	150	95 - 205	5.4	1.7 - 14
HQ:NSC36								
lever A	/Hard/AI BS	110	32.5	1.0	90	30 - 160	1.0	0.1 - 4.6
lever B		90	32.5	1.0	130	45 - 240	2	0.2 - 9
lever C		130	32.5	1.0	65	25 - 115	0.6	0.06 - 2.7
4x								
HQ:XSC11								
lever A	/llord /ALDS	500	30	2.7	15	12 - 18	0.2	0.1 - 0.4
lever B	/Hard/ALR2	210	30	2.7	80	60 - 100	2.7	1.1 - 5.6
lever C		150	30	2.7	155	115 - 200	7	3 - 16
lever D		100	50	2.7	350	250 - 465	42	17 - 90

APPLICATION

* See specifications on page 5

The wear-resistant diamond-like carbon (DLC) coating increases tip durability and lifetime. DLC coated probes are useful for scanning large areas and very hard materials.

		N, X	type
PART NUMBER	HQ: * SC * / Hard / AI BS / *-	15, 50	quantity
		11, 14, 15, 16, 17, 18, 35, 36	series

DPER High Resolution Conductive silicon probes



DPER probes* are made by depositing a thin platinum coating on silicon tips. While the thickness of the coating on a flat cantilever surface is about 15 nm, there is only a 10 nm increase in the tip dimensions compared to bare silicon probes. These probes are recommended for electrical applications requiring higher resolution.

Pt coated resulting tip radius < 20 nm Pt overall coating. 15 nm

SEM image of the DPER

Cantilever Series	Length Ι, ± 5 μm	Width w,±3μm	Thickness ±0.5 μm	Resonance k (typical)	e Frequency Hz (range)	Force (typical)	Constant V/m (range)
4x	▼	▼	▼	▼	▼	▼	•
HQ:DPER-XSC11							
lever A	500	30	2.7	15	12 - 18	0.2	0.1 - 0.4
lever B	210	30	2.7	80	60 - 100	2.7	1.1 - 5.6
lever C	150	30	2.7	155	115 - 200	7	3 - 16
lever D	100	50	2.7	350	250 - 465	42	17 - 90

* See specifications on page 5

DPE

Low Noise Conductive silicon probes



The DPE probes* feature silicon tips and a special structure of conductive layers, which provides a more stable electrical signal and less noise. However, some reduction in resolution for topography images is possible when using DPE probes due to the increased tip radius.

Pt coated resulting tip radius . . . < 40 nm

SEM image of the DPE silicon tip

Length	Width	Thickness	Resonanc	e Frequency	Force	Constant	
l, ±5 μm	w, ±3 μm	±0.5 μm	ł	kHz		N/m	
			(typical)	(range)	(typical)	(range)	
•	•	•	•	•	•	•	
500	30	2.7	15	12 - 18	0.2	0.1 - 0.4	
210	30	2.7	80	60 - 100	2.7	1.1 - 5.6	
150	30	2.7	155	115 - 200	7	3 - 16	
100	50	2.7	350	250 - 465	42	17 - 90	
	Length I,±5 μm 500 210 150 100	Length Width I,±5µm W,±3µm ✓ ✓ 500 30 210 30 150 30 100 50	Length Width Thickness l,±5 μm w,±3 μm ±0.5 μm ✓ ✓ ✓ 500 30 2.7 210 30 2.7 150 30 2.7 100 50 2.7	Length Width Thickness Resonance 1,±5μm w,±3μm ±0.5μm (typical) V V V (typical) 500 300 2.7 15 210 300 2.7 80 150 30 2.7 155 100 50 2.7 350	Length Width Thickness Resonance Frequency l, ± 5 μm w, ± 3 μm ± 0.5 μm kHz (typical) (range) V V V 500 30 2.7 15 210 30 2.7 80 60 - 100 150 30 2.7 155 115 - 200 100 50 2.7 350 250 - 465	Length Width Thickness Resonance Frequency Force 1, ± 5 μm w, ± 3 μm ± 0.5 μm kHz (typical) (range) (typical) V <t< td=""></t<>	

* See specifications on page 5

4×

APPLICATION

Topography (a) and in-plane piezoelectric force response (b) images of an approximately 80 nm thick BiFeO, film grown on a LaAIO, substrate taken with a DPER18 probe (now replaced by HQ:DPE-XSC11).

Image courtesy of Zuhuang Chen, Nanyang Technological University.



APPLICATION

DPE probe topography (a) and surface potential (b) images of a fluoroalkane $(F_{12}H_{20})$ on a Silicon substrate. Image was taken using single-pass KFM with an Agilent 5500 by S. Magonov.



PART NUMBER

15, 50, 100 quantity

Pt and Cr-Au Coated T II II II II II Conductive Noncontact (NSC), Contact (CSC) and 4-Lever (XSC) silicon probes



Pyramidal silicon etched probes* with conductive platinum or gold coatings are suitable for a wide range of electrical applications of AFM. Gold and platinum coatings are inert, which makes these probes applicable for many experiments in biology and chemistry.

Pt coated resulting tip radius < 30 nm	Cr-Au coated resulting tip radius	< 35 nm
Pt overall coating	Au overall coating	30 nm
	Cr overall sublaver	20 nm

SEM image of the conducting silicon tip

Cantilever	Available	Length	Width	Thickness	Resonanc	e Frequency	Force	Constant
Series	Coatings	l, ± 5 μm	w, ± 3 µm	±0.5 µm	ł	κHz		N/m
					(typical)	(range)	(typical)	(range)
	▼	▼	•	▼	•	▼	▼	▼
HQ:NSC14	/Cr-Au, /Pt	125	25	2.1	160	110 - 220	5.0	1.8 - 13
HQ:NSC15	/Cr-Au, /Pt	125	30	4.0	325	265 - 410	40	20 - 80
HQ:NSC16	/Cr-Au,	225	37.5	7.0	190	170 - 210	45	30 - 70
HQ:CSC17	/Cr-Au, /Pt	450	50	2.0	13	10 - 17	0.18	0.06 - 0.40
HQ:NSC18	/Cr-Au, /Pt	225	27.5	3.0	75	60 - 90	2.8	1.2 - 5.5
HQ:NSC19	/Cr-Au	125	22.5	1.0	65	25 - 120	0.5	0.05 - 2.3
[]]								
HQ:NSC35								
lever A		110	35	2.0	205	130 - 290	8.9	2.7 - 24
lever B	/Cr-Au, /Pt	90	35	2.0	300	185 - 430	16	4.8 - 44
lever C		130	35	2.0	150	95 - 205	5.4	1.7 - 14
HQ:NSC36								
lever A		110	32.5	1.0	90	30 - 160	1.0	0.1 - 4.6
lever B	/Cr-Au, /Pt	90	32.5	1.0	130	45 - 240	2	0.2 - 9
lever C		130	32.5	1.0	65	25 - 115	0.6	0.06 - 2.7
								
HQ:CSC37								
lever A		250	35	2.0	40	30 - 55	0.8	0.3 - 2
lever B	/Cr-Au, /Pt	350	35	2.0	20	15 - 30	0.3	0.1 - 0.6
lever C		300	35	2.0	30	20 - 40	0.4	0.1 - 1
HQ:CSC38								
lever A		250	32.5	1.0	20	8 - 32	0.09	0.01 - 0.36
lever B	/Cr-Au	350	32.5	1.0	10	5 - 17	0.03	0.003 - 0.13
lever C		300	32.5	1.0	14	6 - 23	0.05	0.005 - 0.21
4x								
HQ:XSC11								
lever A		500	30	2.7	15	12 - 18	0.2	0.1 - 0.4
lever B	/Pt	210	30	2.7	80	60 - 100	2.7	1.1 - 5.6
lever C	/10	150	30	2.7	155	115 - 200	7	3 - 16
lever D		100	50	2.7	350	250 - 465	42	17 - 90
						* S(e specificati	ions on page 5

APPLICATION

AFM is capable of mapping different electric properties of materials to topography images. These data can be used for analysis of the structure and composition of heterogeneous samples as well as for quantitative characterization of individual grains or defects on the surface. Electric properties of a sample can be mapped using probes with conducting coatings, when AC or DC bias is applied between the tip and the sample. Contact mode or two-pass operation techniques can be used for this purpose.



Although traditional piezoelectric and ferroelectric materials are often the samples studied using piezoresponse force microscopy, Minary-Jolandan and Yu showed that the electromechanical properties of collagen fibrils can also be investigated with PFM. They found via high resolution PFM with a Pt coated CSC17 probe (now upgraded to HQ:CSC17/ Pt) that collagen fibrils have piezoelectrically heterogeneous gap and overlap regions. The gap regions exhibit little to no piezoelectricity, while the overlap regions show piezoelectricity. Images (a) and (d) show the topography of the collagen fibril, while (b) and (e) show the PFM amplitude. (c) and (f) are the 2ω signal measured to rule out any electrostatic interference with the PFM signal. The Pt only coating on the CSC17 probe (now upgraded to HQ:CSC17/Pt) allowed for the resolution of features ~30 nm. (Minary-Jolandan, M. and Yu, M.-F.; ACS Nano 2009, 3, 1859-1863.)



		N, C, X	type
		11, 14, 15, 16, 17, 18, 19, 35, 36, 37, 38	series
PART NUMBER	HQ: * SC * / * / *	15, 50, 100	quantity
		/Cr-Au, /Pt	coating

Co-Cr Coated Magnetic Noncontact (NSC) silicon probes



Two HQ:NSC probe* models are available with a special coating for Magnetic Force Microscopy. The coating consists of a 60 nm cobalt layer on the tipside and is protected from oxidation with a 20 nm chromium film. The cantilever parameters are optimized for stable measurements of topography and magnetic properties.

Co-Cr coated tip < 60 nm	Backside Al coating
Co tipside coating 60 nm	
Cr tipside coating 20 nm	Coercitivity

SEM image of the magnetic silicon tip

Cantilever Series	Available Coatings	Length	Width w.±3um	thickness	Resonance	e Frequency	Force	Constant
		., p	, p		(typical)	(range)	(typical)	(range)
⊥ ▼	•	▼	▼	▼	▼	▼	▼	▼
HQ:NSC18	/Co-Cr/AI BS	225	27.5	3.0	75	60 - 90	2.8	1.2 - 5.5
HQ:NSC36								
lever A		110	32.5	1.0	90	30 - 160	1.0	0.1 - 4.6
lever B	/Co-Cr/AI BS	90	32.5	1.0	130	45 - 240	2	0.2 - 9
lever C		130	32.5	1.0	65	25 - 115	0.6	0.06 - 2.7

* See specifications on page 5

Hi'Res-C High Resolution silicon probes

100 nm

SEM image of the Hi'Res-C

The Hi'Res-C probes* suffer less contamination than silicon probes and are capable of obtaining many high-resolution scans, although they do require special care in use. Due to the small tip curvature radius, the tip-sample attraction force is minimized.

Advantages of Hi'Res-C are noticeable when scanning small areas (< 250 nm) and flat samples (R_a < 20 nm). On larger images, the resolution is similar to that of General Purpose probes.

Spike radius	Overall coating:
Spike height	Au overall coating
Spike material	Cr overall sublayer
	The coating does not cover the spike!

Cantilever	Available	Length	Width	Width Thickness	Resonanc	e Frequency	Force Constant	
Series	Coatings	l, ±5 μm	w, ± 3 µm	±0.5 μm	kHz		N/m	
					(typical)	(range)	(typical)	(range)
∎ ▼	•	▼	▼	▼	▼	▼	▼	▼
Hi'Res-C14	/Cr-Au	125	25	2.1	160	110 - 220	5.0	1.8 - 13
Hi'Res-C15	/Cr-Au	125	30	4.0	325	265 - 410	40	20 - 80
Hi'Res-C19	/Cr-Au	125	22.5	1.0	65	25 - 120	0.5	0.05 - 2.3

* See specifications on page 5

APPLICATION

The advantages of the Hi'Res-C probes are noticeable on scans less than 250 nm in size. The tip radius of 1 nm allows high resolution imaging of nanometer-sized objects like single molecules, ultrathin films, and porous materials in air.

(a) Height image of polydiacetylene crystal obtained with Dimension 5000 SPM microscope and Hi'Res-C probe. Scan size 15 nm. A single defect in the molecular lattice of PDA crystal is visible. (b) Height image of PDA crystal obtained with Agilent 5500 SPM microscope and Hi'Res-C14 probe. Scan size 23 nm. Molecular lattice of PDA is observed only.

Images courtesy of Dr. S. Magonov, Agilent Technologies.





APPLICATION

Topography (a) and magnetic (b) images of a Co mono domain particle obtained in Lift Mode using a NSC36 series cantilever with Co-Cr coating (now upgraded to HQ:NSC36/Co-Cr/Al BS). Image courtesy of Prof. V. Shevyakov, MIET.



		14, 15, 19	series
PAKI NUMBER	HI'Kes - C * / Cr-Au / *	5, 15	quantity



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Calibration gratings from the TGXYZ series are arrays of different structures comprising rectangular silicon dioxide steps on a silicon wafer. The small square in the center with dimensions 500 µm by 500 µm includes circular pillars and holes, as well as lines in the X- and Ydirection with a pitch of 5 µm. The large square with dimensions 1 mm by 1 mm contains square pillars and holes with a pitch of 10 μ m.

Part number	Step height*	Height accuracy	Pitch	Pitch accuracy
•	•	•	•	•
TGXYZ01	20 nm	2%	5 and 10 µm	0.1 µm
TGXYZ02	100 nm	3%	5 and 10 µm	0.1 µm
TGXYZ03	500 nm	3%	5 and 10 µm	0.1 µm



The dimensions marked * are given for reference only. The actual step height, shown on the label of the individual grating box may differ slightly from the nominal value.

APPLICATION

The TGXYZ calibration gratings are intended for vertical and lateral calibration of SPM scanners. The vertical non-linearity can be compensated for by using several calibration gratings with different nominal step heights.

TGX Series



SEM image of a TGX01 grating

The silicon calibration grating TGX is an array of square holes with sharp undercut edges formed by the (110) crystallographic planes of silicon. The typical radius of the edges is less than 5 nm.

Active area
Chip dimensions
Edge radii
$Pitch \ldots \ldots \ 3\mu m$
Pitch accuracy
Step height*



The dimensions marked * are given for reference only.

APPLICATION

TGX calibration gratings are intended for determination of the tip aspect ratio and for lateral calibration of SPM scanners. The gratings can also be used for detection of lateral non-linearity. hysteresis, creep, and cross-coupling effects.

Please note: The TGXYZ, TGX, TGF11, and PA Series Calibration Gratings, are available either mounted on a round metal plate with Ø12mm or unmounted. For ordering information visit www.spmtips.com

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TGF11 Series



The TGF calibration gratings feature one-dimensional arrays of trapezoidal steps etched into a silicon substrate. The sidewalls of the structures are very smooth and planar surfaces with well-defined orientation formed by the (111) crystallographic planes in monocrystalline silicon. The sidewalls and the horizontal top surfaces form an angle of 54°74'.

Part number
Active area
Chip dimensions
Pitch
Pitch accuracy 0.1 μm



The step height value is given for information only, not for vertical calibration purposes.

Step height* 1.75 μm

APPLICATION

TGF11 grating can be used for the assessment of scanner nonlinearity in the vertical direction. Direct calibration of the lateral force can be obtained by analyzing the contact response measured on the flat and sloped facets. This can be done for the calibration of conventional Si probes or cantilevers with an attached colloidal particle with any radius of curvature up to 2 µm.

PA Series



SEM image of a PA01 structure Scan size 1 µm

Sample for characterization of tip shape with hard sharp pyramidal nanostructures.
The structures are covered by a highly wear-resistant layer.

Part number
Pyramid base
Pyramid height
Smallest edge radii
Active area
Chip dimensions

APPLICATION

The exact shape of the scanning probe tip is very important for obtaining AFM images of high quality and accuracy. As new AFM tips with nanometer radii of curvature become widespread, periodic structures that have surface features of similar or greater sharpness should be used to estimate the parameters of the tip.

HOPG



Typical STM image of HOPG with superimposed graphene structure

Density								. 2.266 g/cm ³
---------	--	--	--	--	--	--	--	---------------------------

Thermal conductivities:

thermal conductivity parallel (002)	
thermal conductivity perpendicular (002)	$\dots \dots \dots \dots \dots \dots .8 \pm 1 \text{ W/(m·K)}$
electrical conductivity parallel (002)	$2.1 \pm 0.1 \times 10^{6} [(\Omega \cdot m)^{-1}]$
electrical conductivity perpendicular (002)	5x 10^2 [($\Omega \cdot m$) ⁻¹]

There are several grades of single - or doublesided HOPG with thickness 1 mm or more:

	ZYA Grades	ZYB Grades	ZYH Grades	
	▼	▼	▼	
Mosaic spread	0.4°±0.1°	0.8°±0.2°	3.5°± 1.5°	

APPLICATION

HOPG terminated with a graphene layer can serve as an ideal atomically flat surface to be used as a substrate or standard for SPM investigations. This is also an easily "cleavable" material with a smooth surface, which is vital for SPM measurements that require a uniform, flat and clean substrate.



PLEASE NOTE

The TGXYZ, TGX, TGF11, and PA Series Calibration Gratings, are available either mounted on a round metal plate with Ø12mm or unmounted. For ordering information visit www.spmtips.com

	Probe Type	Characteristics			Tip Material, Coating	
Materials characterization	HQ:NSC18	Force modulation	~2.8	~75	Silicon, Al or no Al backside coating	~8
	HQ:NSC14	Phase imaging	~5.0	~150	Silicon, Al or no Al backside coating	~8
General topology imaging	HQ:NSC17	Contact imaging	~0.18	~13	Silicon, Al or no Al backside coating	~8
	HQ:NSC15	Intermittent/non-contact Imaging	~40	~325	Silicon, Al or no Al backside coating	~8
	HQ:NSC14	Intermittent contact imaging	~5.0	~150	Silicon, Al or no Al backside coating	~8
Topology imaging for life science	HQ:NSC14	Intermittent contact imaging	~5.0	~150	Silicon, Al or no Al backside coating	~8
	HQ:NSC18/ Cr-AuBS	Intermittent contact imaging in fluid	~2.8	~75	Silicon, Au backside coating	~8
	HQ:NSC18/Cr-AuBS	Contact imaging in fluid	~2.8	~75	Silicon, Au backside coating	~8
	HQ:CSC17	Contact imaging	~0.18	~13	Silicon, Al or no Al backside coating	~8
	HQ:CSC38 (three lever)	Contact imaging	~0.09 ~0.03 ~0.05	~20 ~10 ~14	Silicon, Al or no Al backside coating	~8
	Hi'Res-C14/Cr-Au	High resolution Imaging	~5.0	~160	Carbon spike, Al backside coating	~1
	HQ:NSC36 (three lever)	Intermittent contact imaging	~1.0 ~2.0 ~0.6	~90 ~130 ~65	Silicon, Al or no Al backside coating	~8
Probes for mechanical property	HQ:NSC14/Hard	Specially coated for durability	~5.0	~160	DLC coating, Al back- side coating	<20
measurements in Life Science	HQ:NSC18	Force modulation	~2.8	~75	Silicon, Al or no Al backside coating	~8
	HQ:CSC17/Cr-Au	Chemical inertness, functionalization	~0.18	~13	Cr-Au coating on both sides	<35
Probes for high resolution imaging	Hi'Res-C14/Cr-Au	Nanometer-sized objects like single molecules, ultrathin films, and porous materials in air	~5.0	~160	Carbon spike, Cr-Au coating on both sides (spike not coated)	~1
Electrical applicatons in	HQ:DPER/XS11, Cantilever A	High resolution	~0.2	~15	Pt coating on both sides	<20
vacuum	HQ:DPE/XSC11, Cantilever A	High sensitivity, low wear	~0.2	~15	Pt coating on both sides	<40

 $k - Force constant; f_{o} - Resonance frequency$

	Probe Type	Characteristics			Tip Material, Coating	
Electrical applications for	HQ:DPER/XSC11, Cantilever C	High resolution	~7	~155	Pt coating on both sides	<20
PFM, TUNA, SCM, SSRM	HQ:DPE/XSC11, Cantilever C	Dynamic/contact electrical mode, high sensitivity, low wear	~7	~155	Pt coating on both sides	<40
	HQ:CSC17/Cr-Au	Chemical inertness, functionalization	~0.15	~12	Cr-Au coating on both sides	<35
	HQ:NSC18/Pt	Dynamic/contact electrical mode	~2.8	~75	Pt coating on both sides	<30
Electrical applications for	HQ:DPER/XSC11, Cantilever C	High resolution	~7	~155	Pt coating on both sides	<20
EFM, SKPM, Voltage Modulation, Scan- ning Impedance Microscopy, SGM	HQ:DPE/XSC11, Cantilever C	Dynamic/contact electrical mode, high sensitivity, low wear	~7	~155	Pt coating on both sides	<40
	HQ:NSC14/Pt	General stability in conductive modes	~7	~155	Pt coating on both sides	<30
	HQ: NSC14/Cr-Au	Chemical inertness, functionalization	~7	~155	Cr-Au coating on both sides	<35
	HQ:DPER/XSC11, Cantilever B	High resolution	~2.7	~80	Pt coating on both sides	<20
	HQ:DPE/XSC11, Cantilever B	High sensitivity, low wear	~2.7	~80	Pt coating on both sides	<40
	HQ:NSC18/Pt	General stability in conductive modes	~2.8	~75	Pt coating on both sides	<30
	HQ:NSC18/Cr-Au	Chemical inertness, functionalization	~2.8	~75	Cr-Au coating on both sides	<35
Magnetic force	HQ:NSC18/Co-Cr/ ALBS	Magnetic coating	~2.8	~75	Co-Cr coating, Al backside coating	<90

 $k - Force constant; f_{o} - Resonance frequency$

Notes

1	
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